PATENT COOPERATION TREATY

From the INTERNATIONAL SEARCHING AUTHORITY		
То:	PCT	
see form PCT/ISA/220	WRITTEN OPINION OF THE INTERNATIONAL SEARCHING AUTHORITY (PCT Rule 43bis.1)	
	Date of mailing (day/month/year) see form PCT/ISA/220 (page 2)	
Applicant's or agent's file reference see form PCT/ISA/220	FOR FURTHER ACTION See paragraph 2 below	
International application No. International filing date PCT/DE2004/001449 7/7/2004	e (day/month/year) Priority date (day/month/year) 9/12/2003	
International Patent Classification (IPC) or both national classific B81C1/00 Applicant Robert Bosch GMBH	ation and IPC	
Box No. IV Lack of unity of invention Box No. V Reasoned statement under Rule 43bis.1 citations and explanations supporting s Box No. VI Certain documents cited Box No. VII Certain defects in the international app Box No. VIII Certain observations on the internation 2. FURTHER ACTION If a demand for international preliminary examination is m International Preliminary Examining Authority ("IPEA") exceptions of this International Searching Authority will not be If this opinion is, as provided above, considered to be a written	ard to novelty, inventive step and industrial applicability (a)(i) with regard to novelty, inventive step or industrial applicability; such statement dication all application adde, this opinion will be considered to be a written opinion of the sept that this does not apply where the applicant chooses an Authority notified the International Bureau under Rule 66.1 bis(b) that written e so considered. en opinion of the IPEA, the applicant is invited to submit to the IPEA s, before the expiration of 3 months from the date of mailing of Form	
Name and mailing address of the ISA/	Authorized officer Meister, M	
Facsimile No. Express Mail: lev 839 709 509 US Telephone No.		

WRITTEN OPINION OF THE INTERNATIONAL SEARCHING AUTHORITY

International application No. PCT/DE2004/001449

citations and explanati			1489 4
. Statement			
Novelty (N)	Claims	4,5	YES
	Claims	103, 6-8	NO
Inventive step (IS)	Claims	none	YES
inventive step (13)	Claims	1-8	NO
Industrial applicability (IA) Claims		1-8	
	Claims Claims	none	YES NO
	Ciamis	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	110
Citations and explanations:			
see supplementary page			
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WRITTEN OPINION OF THE INTERNATIONAL SEARCHING AUTHORITY

International application No.

PCT/DE2004/001449

Box	No. I	Basis of this opinion
1.		egard to the language, this opinion has been established on the basis of the international application in the language in twas filed, unless otherwise indicated under this item.
		This opinion has been established on the basis of a translation from the original language into the following language, which is the language of a translation furnished for the purposes of international search (under Rules 12.3 and 23.1(b)).
2.		egard to any nucleotide and/or amino acid sequence disclosed in the international application and necessary to the disclosed in the international application and necessary to the disclosed in the international application and necessary to the
	a. typ	e of material
	Ļ	a sequence listing
		table(s) related to the sequence listing
	b. for	mat of material
	<u> </u>	in written format
		in computer readable form
	c. tim	e of filing/furnishing
		contained in the international application as filed.
		filed together with the international application in computer readable form.
		furnished subsequently to this Authority for the purposes of search.
3.		In addition, in the case that more than one version or copy of a sequence listing and/or table relating thereto has been filed or furnished, the required statements that the information in the subsequent or additional copies is identical to that in the application as filed or does not go beyond the application as filed, as appropriate, were furnished.
4.	Additio	onal comments:
II.		

WRITTEN OPINION OF THE INTERNATIONAL SEARCHING AUTHORITY

International application No. PCT/DE2004/001449

Box No. II Priority
1. The following document has not yet been furnished: copy of the earlier application whose priority has been claimed (Rules 43bis.1 and 66.7(a)). translation of the earlier application whose priority has been claimed (Rules 43bis.1 and 66.7(b)). Consequently it has not been possible to consider the validity of the priority claim. This opinion has nevertheless been established on the assumption that the relevant date is the claimed priority date.
This opinion has been established as if no priority had been claimed due to the fact that the priority claim has been found invalid (Rules 43bis.1 and 64.1). Thus for the purposes of this opinion, the international filing date indicated above is considered to be the relevant date.
3. Additional observations, if necessary:
see supplemenatry page

WRITTEN OPINION OF THE INTERNATIONAL SEARCHING AUTHORITY SUPPLEMENTARY PAGE

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On Point V

Reasoned statement under Article 35(2) with regard to novelty, inventive step, and industrial applicability; citations and explanations supporting such statement

Reference is made to the following documents:

- D1: TILLACK B ET AL.: "MONITORING OF DEPOSITION AND DRY
 ETCHING OF SI/SIGE MULTIPLE STACKS" JOURNAL OF VACUUM
 SCIENCE AND TECHNOLOGY: PART B, AMERICAN INSTITUTE OF
 PHYSICS. NEW YORK, US, vol. 14, issue 1, 1996, pages 102105, X000198643 ISSN: 1071-1023
- D2: US-B-6 198 0981 (LAOU PHILIPS) March 6, 2001 (2001-03-06)
- D3: US-B-6 210 9881 (FRANKE ANDREA ET AL.) April 3, 2001 (2001-04-03)
- D4: PREMACHANDRAN C S ET AL.: "A novel electrically conductive wafer through hole filled via interconnect for 3D MEMS packaging" 2003 PROCEEDINGS 53RD ELECTRONIC COMPONENTS AND TECHNOLOGY CONFERENCE. (ECTC). NEW ORLEANS, LA, MAY 27 30, 2003, PROCEEDINGS OF THE ELECTRONIC COMPONENTS AND TECHNOLOGY CONFERENCE, NEW YORK, NY: IEEE, US, vol. CONF. 53, May 27, 2003 (2003-05-27), pages 627-630, XP010648307 ISBN: 0-7003-7991-5
- 2. The present application does not fulfill the requirements of Article 33(1) PCT, because the object of Claims 1 and 7 is not novel as defined in Article 33(2) PCT.
- 2.1 Document D1 discloses (cf. paragraph "Introduction", the references in parentheses relate to this document):

A method for producing etched holes and/or etched trenches on components ("novel electronic and optoelectronic devices") based on silicon ("Si/SiGe") and/or a layered silicon/insulator structure,

wherein a germanium-containing layer and/or a germanium layer is provided at the point at which or in whose surroundings an etching procedure is to be completed ("selectively etch a layer of Si on GeSi or SiGe on Si"), during the etching procedure germanium and/or germanium compounds are detected ("optical emission spectroscopy"), and the etching procedure is controlled, in particular interrupted, as a function of the detection of germanium and/or germanium compounds (cf. paragraph IV: "... accurate indicator which allows an etch stop within any of the thin films in the stack").

The object of Claim 1 is therefore not novel as defined in Article 33(2) PCT.

2.2 Document D2 discloses (cf. Figure 2 and associated parts of the description, the references in parentheses relate to this document):

A diaphragm sensor unit having a substrate made of silicon (2) or a layered silicon/insulator structure, which comprises a flat diaphragm (3, 4, 6, 7) for implementing a sensor element structure for a sensor ("infrared sensor"),

wherein a germanium and/or germanium-containing layer (7) is provided in the layered structure.

The object of Claim 7 is therefore not novel as defined in Article 33(2) PCT.

The object of Claim 7 is also not novel in regard to document D3 (Article 33(2) PCT).

2.3 Dependent Claims 2-6 and 8 do not contain any features which would fulfill the requirements of the PCT in regard to novelty and/or inventive step in combination with the features of any claim to which they refer.

Lack of novelty (Article 33(2) PCT):

Claims 2, 5, 6: additional features of D1 known (see International Search Report)

Claim 8: additional feature of D2 known (see International Search Report)

Lack of inventive step (Article 33(3) PCT):

Claims 4, 5:

The additional features are disclosed in Document D4 in a comparable context for another material (see "Abstract").

Claim 4 is unclear. It is interpreted in such a way that the layer (11) is removed after the etching procedure is completed (Article 6 PCT).